



Click [here](#) for the 3D model.

### Dimensions

Footprint	7238
L	7.24mm +/-0.38mm
W	3.81mm +/-0.38mm
H	2.79mm +/-0.38mm
S	1.27mm +0.25/-0.13mm
F	3.68mm +0.13/-0.51mm
K	1.52mm MIN
P	0.76mm MIN

### Packaging Specifications

Packaging	T&R, 178mm
Packaging Quantity	500

### General Information

Series	T429 CWR29
Dielectric	MnO <sub>2</sub> Tantalum
Style	SMD Chip
Description	SMD, MnO <sub>2</sub> , Molded, Military Equivalent, Low ESR
RoHS	No
Prop 65	<b>⚠ WARNING:</b> Cancer and reproductive harm - <a href="http://www.p65warnings.ca.gov">http://www.p65warnings.ca.gov</a> .
SCIP Number	652b281f-d242-4453-bc44-0655d646cec3
Termination	Hot Solder Dipped
Qualifications	MIL-PRF-55365/11, CWR29 Style
AEC-Q200	No
Component Weight	349.01 mg
Notes	Note: When Option C Is Selected For Lead Material, Add An Additional 0.38mm To The Tolerances For "L", "W", "H", "K", "F" And "S".
MSL	1

### Specifications

Capacitance	47 uF
Capacitance Tolerance	10%
Voltage DC	15 VDC (85C), 10 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	8% 120Hz 25C
Failure Rate	C (0.01%/1000 Hrs)
Resistance	0.18 Ohms (100kHz 25C)
Ripple Current	913 mA (rms, 100kHz 25C)
Leakage Current	10 uA (5min 25°C)
Testing and Reliability	Surge Testing (10 Cycles At -55C And +85C Before Weibull)